

NCV840XXG Evaluation Board User's Manual

NCV840XXGEVB

The NCV840XXG Evaluation Board has been designed to enable a complete functional and parametric evaluation of the NCV840XXG single channel eFuse high-side driver. This evaluation board has been constructed to easily interface with different test systems and equipment through power terminals and test points located throughout the board. A variant of the evaluation board also has the option to integrate an Arduino Nano and use independent software routines to evaluate capabilities of the NCV840XXG device in a convenient user-friendly manner.

This document gives a detailed description of the NCV840XXG Evaluation Board (TSSOP-14 EP Package) with the bill of materials, board schematic, and a layout overview of the board. The document also provides details on operational aspects of the board and recommended external connections.

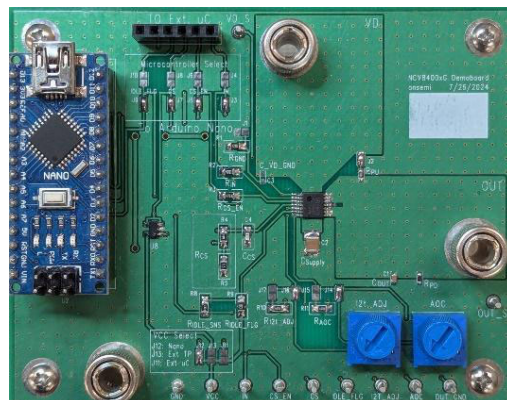
This document should be used with the NCV840XXG datasheet available on www.onsemi.com or the product preview provided with engineering samples. The evaluation board, in general, follows the application diagram, however the datasheet contains full technical details about the NCV840XXG specification, features, protections, diagnostics and other operations.

Features

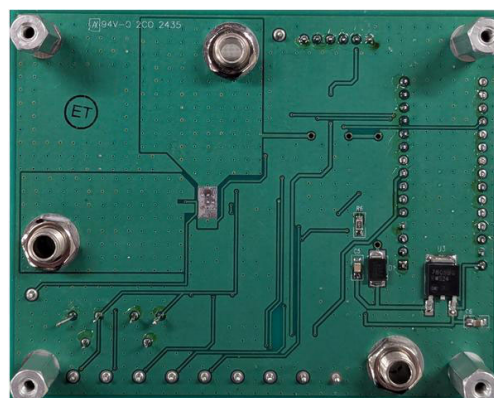
- Power Terminals and Test Points for Drain and OUT Connections
- Test Points for all Logic Pins
- Protection Resistors on GND, Logic and Analog I/O
- Optional Onboard 5 V Regulator
- Optional Connector to External Microcontroller
- On-board Potentiometers on AOC and I2t_ADJ Pins to Allow Evaluation of Adjustable Device and System Protection Features
- Open Load Diagnosis Circuit
- Arduino Nano Integration
- Additional Demonstration Software

Typical Applications

- Replace Fuses in Zonal Car Platforms
- Power on Bulk Capacitors, Resistive, and Inductive Loads
- Automotive / Industrial



(Front Side)



(Back Side)

Figure 1. Evaluation Board

ORDERING INFORMATION

Device
NCV840XXGNTGEVB
NCV840XXGTGEVB

XX represents IC version populated when ordering.

NCV840XXGEVB

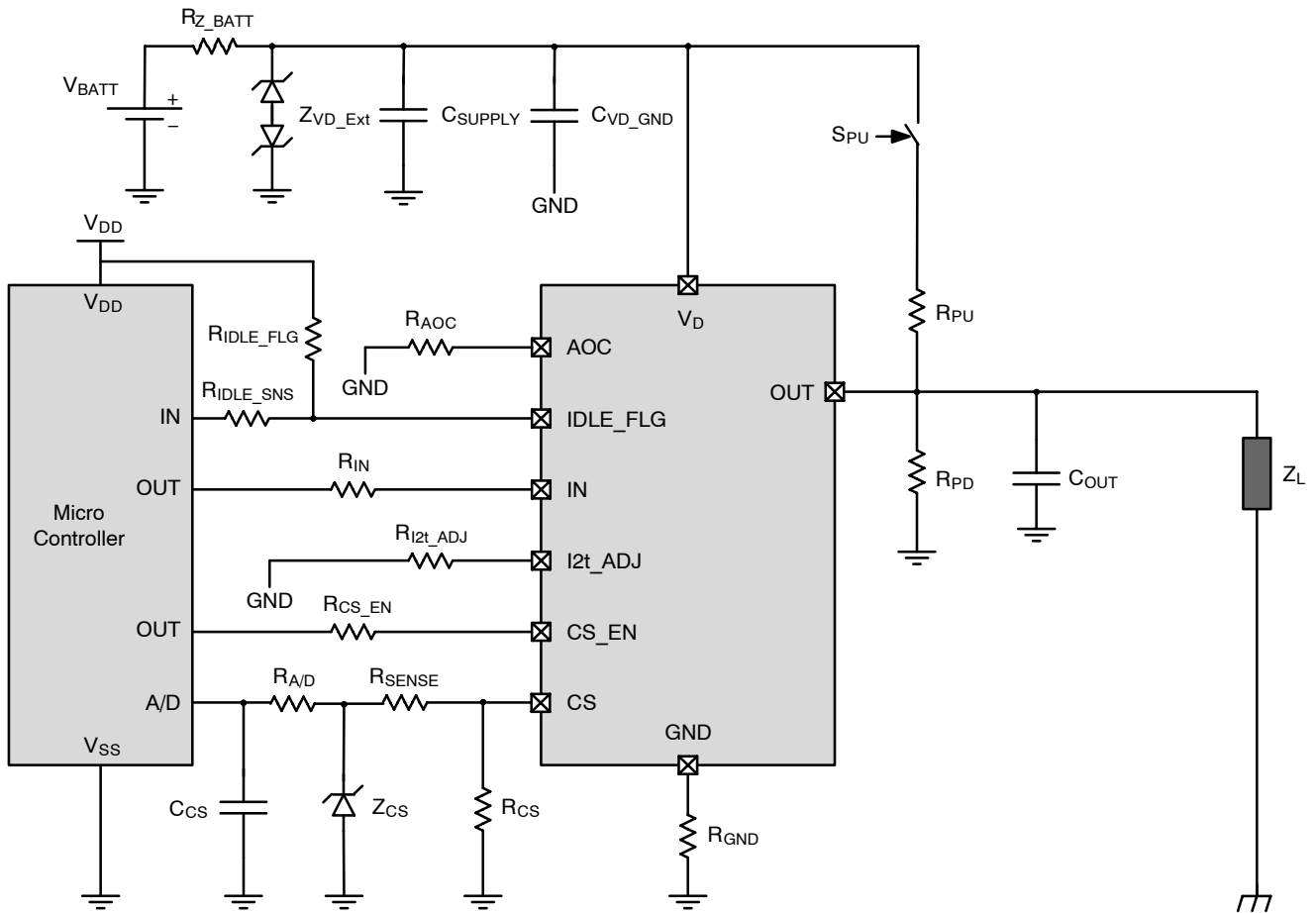


Figure 2. Recommended Application Diagram

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Table 1. RECOMMENDED EXTERNAL COMPONENTS

Reference	Value	Description
R _{IN}	4.7 kΩ	Provides protection of the micro controller during overvoltage and reverse polarity. Ensures the channel is OFF during loss of GND.
R _{CS_EN}	4.7 kΩ	Provides protection of the micro controller during overvoltage and reverse polarity. Ensures the channel is OFF during loss of GND.
R _{IDLE_FLG}	10 kΩ	Open drain resistor to logic level voltage.
R _{IDLE_SNS}	4.7 kΩ	Provides protection of the micro controller during overvoltage and reverse polarity. Ensures the channel is OFF during loss of GND.
R _{AOC}	4.7 kΩ~30 kΩ	Recommended range for selecting overcurrent threshold. Open circuit and short to GND not recommended (Refer <i>Overcurrent Shutdown</i>).
R _{CS}	1.2 kΩ	Current Sense resistor.
R _{SENSE}	4.7 kΩ	Provides protection against overvoltage, reverse polarity, and loss of GND. The value of this resistor should be selected with the micro controller specification.
C _{CS}	100 pF	Current Sense signal filtering.
R _{AD}	4.7 kΩ	Current Sense signal filtering.
Z _{CS}	10 V Zener Diode	Provides protection micro controller during overvoltage at CS. Should be selected with the micro controller specification.
R _{PU}	1.5 kΩ	Polarizes the NCV840XXG output during OFF state open load diagnosis.
R _{PD}	47 kΩ	Output polarization. Improves the NCV840XXG immunity to electromagnetic noise and also used for short to V _{BATT} detection.
S _{PU}	BC807	Switches the battery voltage for OFF state open load diagnostic.
R _{GND}	47 Ω	Provides protection during over-voltage.
Z _{VD_Ext}	30 V Zener Diode	Provides protection of the device during overvoltage.
C _{SUPPLY}	100 nF	Filtering of voltage spikes on the battery line.
C _{VD_GND}	47 nF	Provides drain voltage stability during fast transients such as overload.
C _{OUT}	10 nF	Protection during ESD and BCI on output.

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ELECTRICAL SPECIFICATIONS

Table 2. MAXIMUM RATINGS (Note 1)

Rating	Symbol	Min	Max	Unit
SUPPLY VOLTAGE				
Steady State Supply Voltage – NCV840XXGNTGEVB	V _D	6	18	V
Steady State Supply Voltage – NCV840XXGTGEVB		-0.3	18	
Max Supply Voltage for Transient Operations (Note 1)			28	V
CONNECTIONS TO DIGITAL INPUT PINS: IN, CS_EN				
Maximum Current Capability	I _{TP_DIG_IN}	-I _{DIG_IN_MAX} (Note 2)	I _{DIG_IN_MAX} (Note 2)	mA
Maximum Voltage Capability	V _{TP_DIG_IN}	-0.3	V _{DIG_IN_MAX} (Note 2)	V
CONNECTIONS TO IDLE_FLG PIN				
Maximum Current Capability	I _{TP_IDLE_IN}	-I _{IDLE_MAX} (Note 2)	I _{IDLE_MAX} (Note 2)	mA
Maximum Voltage Capability	V _{TP_IDLE_IN}	-0.3	V _{IDLE_MAX} (Note 2)	V
CONNECTIONS TO CURRENT SENSE OUTPUT				
Current at Current Sense Output	I _{TP_CS_MAX}	-25	I _{CS_Fault_ILIM} (Note 2)	mA
Voltage at Current Sense Output	V _{TP_CS_MAX}	-0.3	V _D	V
TEST POINTS TO ANALOG INPUT PINS: AOC PIN, I2T_ADJ PIN				
Current at Input Pin	I _{TP_ANA_IN}	-I _{ANA_IN_MAX} (Note 2)	I _{ANA_IN_MAX} (Note 2)	mA
Voltage at Input Pin	V _{TP_ANA_IN}	-0.3	V _{ANA_IN_MAX} (Note 2)	V
OUTPUT CONNECTION				
Drain-Source Voltage at Power Transistor	V _{DS_MAX}		Z _{CL}	V
Max Output Current – Steady State	I _{OUT_MAX}		15 (Note 3)	A
Max Output Current – Transient	I _{OUT_MAX_TRAN}		I _{LIM}	A
CONNECTIONS TO DEVICE GROUND				
Current through GND Pin	I _{TP_GND}	-I _{GND} (Note 2)	I _{GND} (Note 2)	mA
OPERATING TEMPERATURE				
Operating Ambient Temperature – NCV840XXGNTGEVB	T _{AMB}	-40	85 (Note 4)	°C
Operating Ambient Temperature – NCV840XXGTGEVB		-40	125	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. For transient application only. Extended operation at absolute maximum voltage may affect device reliability.
2. Refer to product datasheet.
3. Limited by max rating of power terminal connector.
4. Limited by operation capability of Arduino-Nano.

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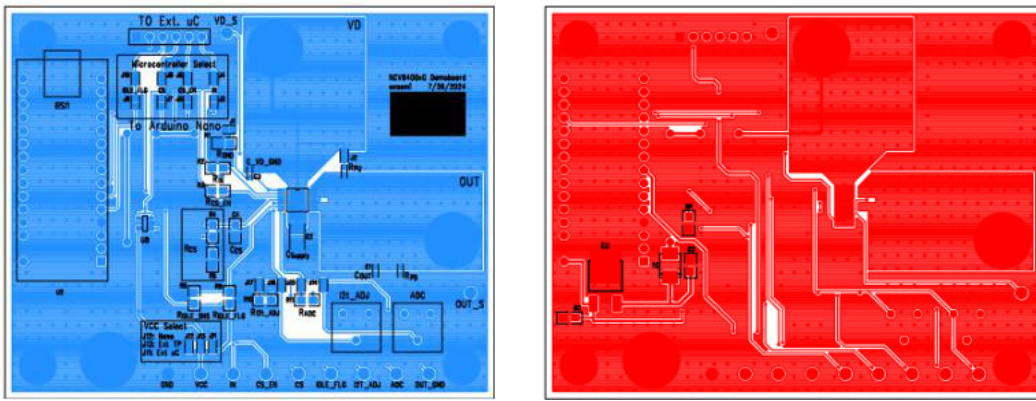


Figure 3. Board Layout (on Left) Top Layer, (on Right) Bottom Layer

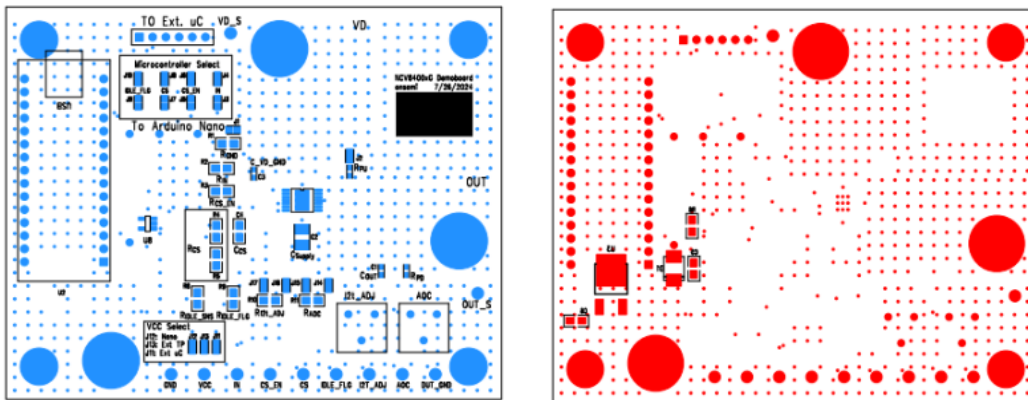


Figure 4. Board Layout without Traces (on Left) Top Layer, (on Right) Bottom Layer

Table 3. JUMPER DEFINITIONS

Jumper	Purpose	Default Connection
J1	To connect device GND pin to GND plane	NP
J2	To connect Pull Up resistor from OUT to VD for OSOL diagnosis	P
J3, J5, J7, J9	To connect IN, CS_EN, CS and IDLE_FLG respectively to Arduino Nano I/O	P: NCV840XXGNTGEVB NP: NCV840XXGTGEVB
J4, J6, J8, J10	To connect IN, CS_EN, CS and IDLE_FLG respectively to external microcontroller	NP
J11	To supply IDLE_FLG pull-up voltage via external microcontroller	NP
J12	To supply IDLE_FLG pull-up voltage via Arduino Nano	P: NCV840XXGNTGEVB
J13	To supply IDLE_FLG pull-up voltage via external TP	P: NCV840XXGTGEVB
J14	To connect AOC pin to potentiometer	P
J15	To connect AOC pin to 4.7 kΩ fixed resistor	NP
J16	To connect I2t_ADJ pin to potentiometer	P
J17	To connect I2t_ADJ pin to 4.7 kΩ fixed resistor	NP

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Schematic

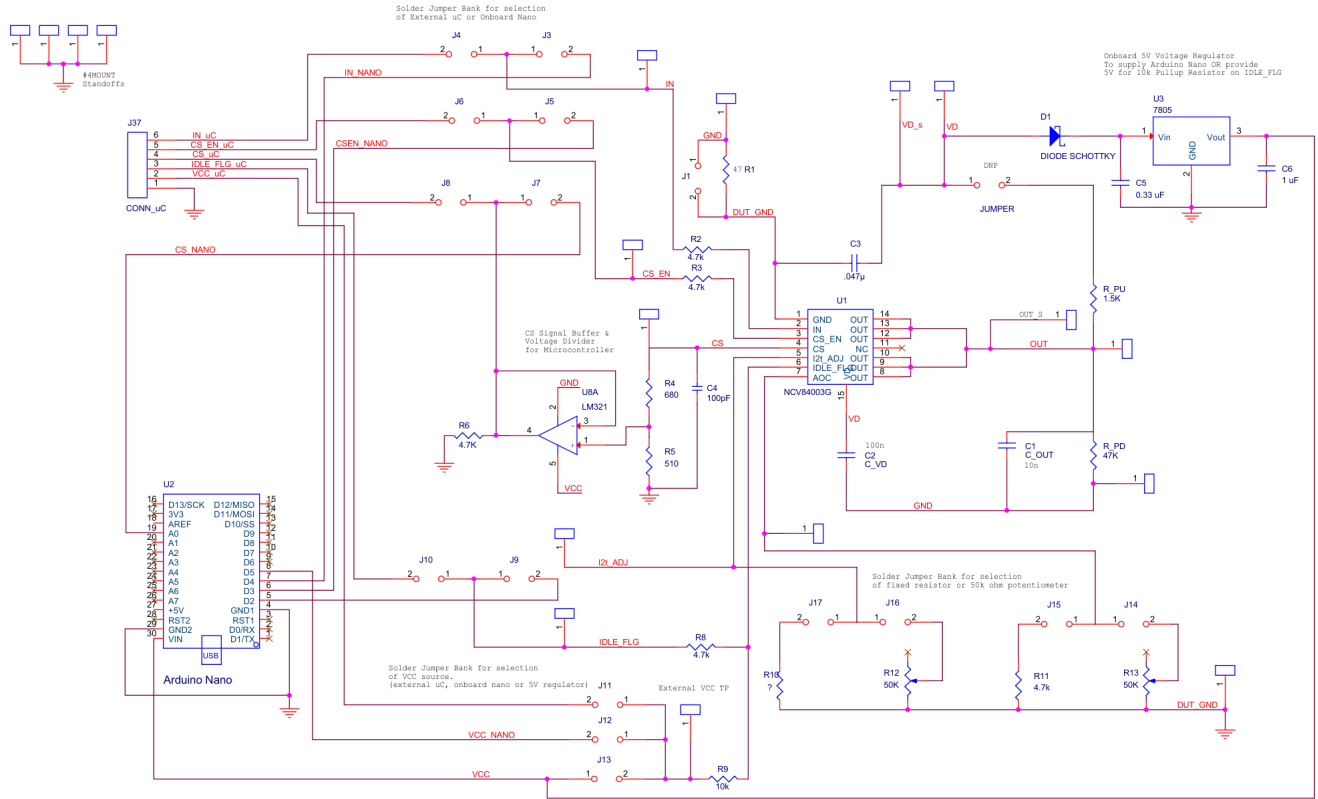


Figure 5. EVB Schematic

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BOARD OPERATION

Supply

The EVB is required to be supplied via the connection VD as highlighted in Figure 6. This input serves as the supply (drain connection) for NCV840XXG as well as for other optional active circuits on the board including the regulator MC7805 that in turn powers an on-board voltage buffer and the Arduino nano. The board is designed to ensure that the performance of the device can be evaluated in the specified nominal operating voltage range. Further, transient operations such as jump start (and associated overcurrent limit), load dump etc. can also be evaluated on the board. At supply voltages lower than 6 V, the regulator can fail to provide sufficient output voltage for Arduino and the buffer. While evaluating for low voltage operations such as under-voltage shutdown and recovery times, it is therefore, recommended to use individual test points for driving logic inputs (Refer [Digital Inputs](#) section). Further, the jumper J13 must be de-populated in such case while using an external logic supply to power IDLE_FLG. It should be noted that the buffer output will not be available at low battery voltages. The drain pin on the device is connected to filter capacitor and an optional capacitor to device GND (as specified per [BOM](#)) for eliminating any unexpected fast transients that may affect device response.

Output

The output terminal can be connected to the desired load per application. While connecting to the output, the cable length and impedance should be noted as it may impact the protection mechanisms such as peak current levels observed in overcurrent detection, or the current slew off time after an over-load detection. The dedicated CL (capacitive load) mode can be exercised to power capacitive loads, if desired (Refer to product datasheet for details on CL mode entry/exit conditions). The board can also be used to switch inductive loads within the maximum rated capability of the device. It should also be noted that the maximum steady state output current is limited by the capability of the power connectors and is specified in the electrical characteristics of this reference document. The test point can be used to monitor voltage at this node using DC multimeters/oscilloscope. As with supply connection, output has a filter capacitor populated on board (as specified per [BOM](#)) to eliminate high frequency noise. Further, referring to Figure 6, the output node is connected to VD through a pull-up resistance R_{PU} and to GND through a pull-down resistor R_{PD} (as specified per [BOM](#)) to diagnose off-state open load and short circuit to battery respectively (Refer to product datasheet for details).

Ground Network

The device needs to be always supplied with a ground connection for it to function as desired. The device response in case of a loss of device or load GND condition is explained in the product datasheet. The evaluation board has

a protection resistor connected to the ground pin to protect and limit the current across the internal ESD's and clamps in case of transient over-voltage events. The test point at GND pin can be used to monitor the ground potential, or to measure the ground current.

Digital Inputs

The digital inputs (IN and CS_EN) as well as the IDLE_FLG input are provided with the option to be driven externally via individual test points or using a plug-in connector to an external microcontroller. Further, there is an optional socket (only on NCV840XXGNTGEVB version) to plug in an on-board Arduino that can drive the digital inputs using the provided software. The user can also load the Arduino with their own software routines to drive the pins as they desire in the application or to observe mode transitions as specified in product datasheet. It should be noted that if evaluation at high ambient temperatures is desired then external test points on NCV840XXGTGEVB should be connected to wires that can withstand temperature. When using an external test point, a 3.3 V/5 V compatible logic input can be interfaced to these pins. Jumpers J3–J4 and J5–J6 can be used to connect on-board Arduino or external microcontroller to IN and CS_EN respectively (Refer Table 3 for details). The digital inputs are interfaced to the device with series protection resistors that limit the current through logic ESD's in case of transient over-voltage events.

If evaluation of IDLE functionality is desired, the IDLE_FLG pin needs to be supplied with a logic level supply through the on-board pull-up resistor (Refer to product datasheet for details on IDLE_FLG functionality). The EVB provides different options for powering the IDLE_FLG pin. The jumper bank J11–J13 can be used to select between an external logic VCC supply connected to the test point (as on NCV840XXGTGEVB), or an Arduino powered VCC (as on NCV840XXGNTGEVB), or using an external microcontroller for the same purpose. Refer to Figure 6 and Table 3 for depiction and details on jumper connection. It should be noted that only one jumper connection should be enabled at a time. The IDLE_FLG response from the device can be sensed and monitored using different options similar to the ones described above for the pull-up supply. Jumpers J9 or J10 per Table 3 can be used to connect the IDLE_FLG output from the device to on-board Arduino or external microcontroller connector respectively. Additionally, the test point connection can also be used to monitor IDLE_FLG output.

Analog Inputs

Analog Input pins including AOC and I2t_ADJ must be connected to an external resistor to configure the desired overcurrent and I2t protection settings on the device (Refer to product datasheet for details on these settings). This EVB provides two options for connecting these resistors using

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jumpers J14–J17 (as described in Table 4). As a default connection, AOC and I2t_ADJ pins are connected to on-board potentiometers (Refer to [BOM](#) for details on potentiometers) that allow the user to evaluate the full range of configurable options on these pins. Alternatively, if performance in default setting is desired, then $R_{AOC} = R_{I2t_ADJ} = 4.7 \text{ k}\Omega$ can be connected to these pins using jumpers J15 and J17 respectively. Users can also replace these resistors manually to other values as desired per the application provided they are footprint compatible. These resistors are always referenced to the device GND on the EVB. Lastly, the voltage levels at these pins can be monitored via dedicated test points.

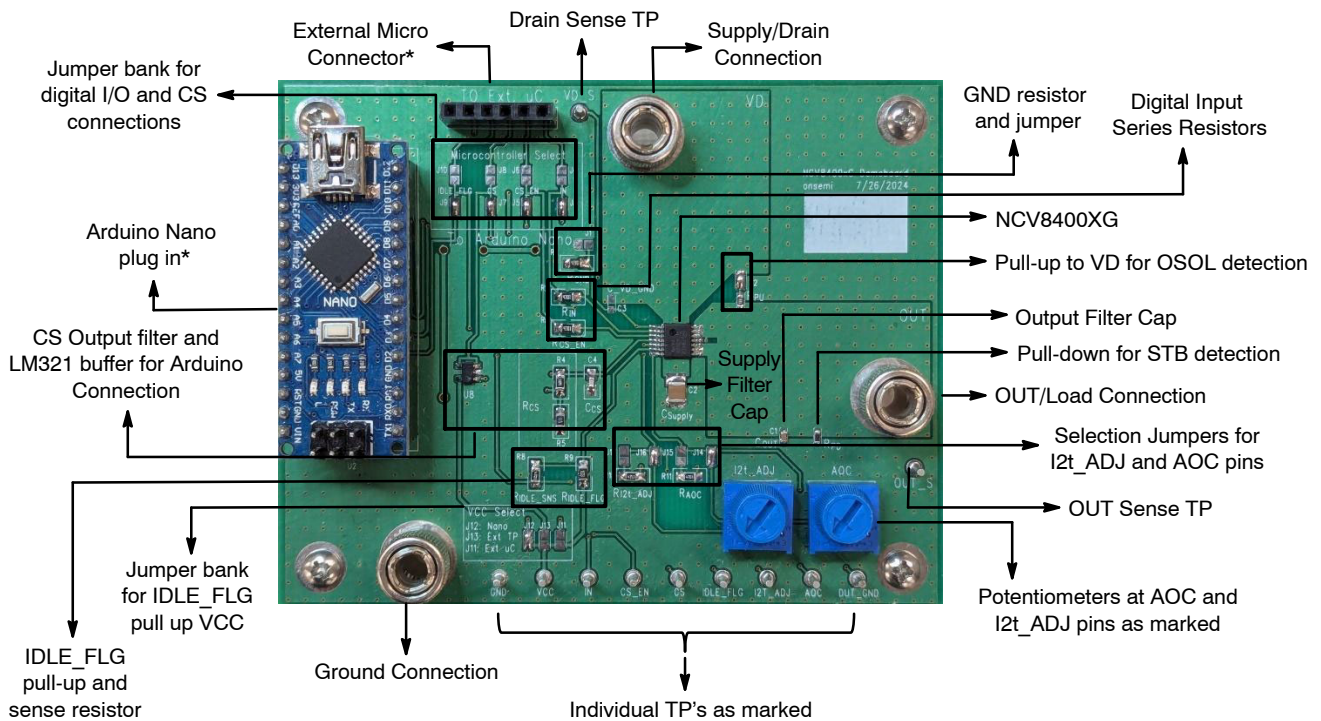
Current Sense Output

The current sense output is connected to a network of resistors and a filter capacitor (values per the [BOM](#)

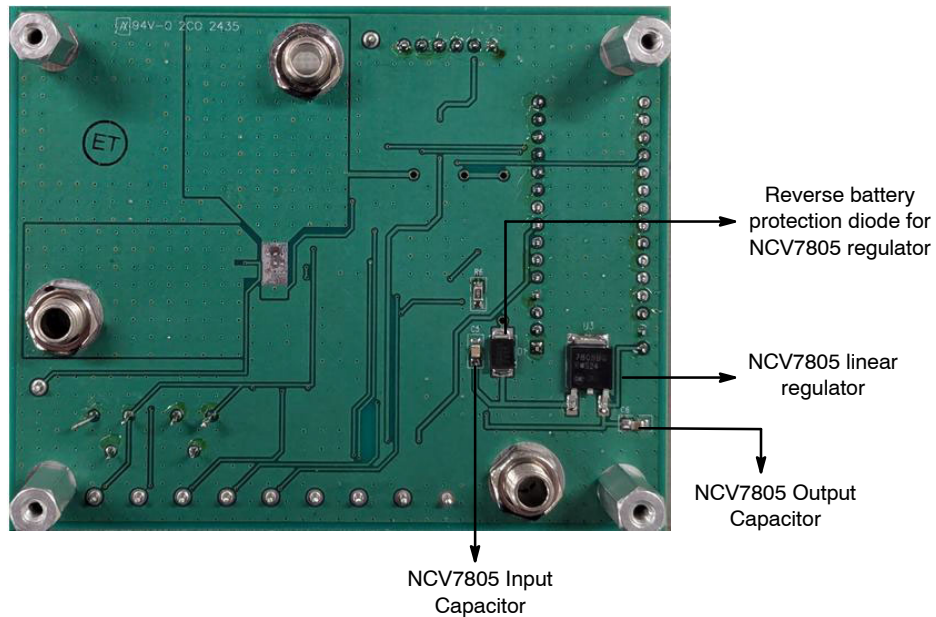
specified). The output voltage on the resistor network can be measured directly on the dedicated test point (Refer Figure 6), or the jumpers J7–J8 can be used to route this signal to on-board Arduino/external microcontroller connector (as explained in Table 3). The current sense output going to this jumper bank is attenuated via the potential divider at the CS pin. This is done to protect the Arduino/micro inputs from getting damaged at high CS output voltages. In addition, the EVB also consists of a buffer (LM321) to prevent CS pin loading before connecting it to Arduino input. While monitoring the CS output voltage for load current estimation/diagnosis, the required CS operation voltage and normal/fault CS output current levels must be considered as specified per the product datasheet. Further, when processing/digitizing CS voltage through Arduino or microcontroller, the on-board attenuation must be accounted for as explained in [Operational Guidelines](#).



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a) Annotated EVB Top Side



b) Annotated EVB Bottom Side

Figure 6. Annotated EVB

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OPERATIONAL GUIDELINES

The test procedure below will demonstrate the general functionality of the NCV840XXG evaluation boards:

1. Connect a DC input voltage at VD connector within the recommended operating limits as specified. The power supply should be capable of handling the load inrush and steady state power requirements. If required, external bulk capacitors can be connected to the power supply. DO NOT switch on power in this step.
2. Connect the desired load per application to the OUT connector.
3. Configure the digital input driving connections to either on-board Arduino or use the external microcontroller connector interface (on NCV840XXGNTGEVB). Alternatively, individual test points can also be connected (on NCV840XXGTGEVB) to external pulse signal generators/DC power supplies compatible with CMOS logic levels. The voltage and temperature limitations of these alternatives have been presented in the sections above.

$$V_{CS_Attn} = (R5 / (R4 + R5)) \times V_{CS} = (510 / (510 + 680)) \times V_{CS} = 0.428 \times V_{CS} \text{ (values per specified BOM)} \quad (\text{eq. 1})$$

So, for a maximum current sense output current of 10 mA (Refer to $I_{CS_Fault_ILIM}$ and I_{CS_SAT} specifications per datasheet), V_{CS} input going into LM321 can be calculated as: $V_{CS_Attn} = 0.428 \times 10 \text{ mA} \times 1190 \Omega = 5.1 \text{ V}$. This signal

4. While using Arduino, the provided software code can be used, or the user can program the Arduino as desired.
5. The oscilloscope probes, if desired, can be connected to the test points to monitor signal transitions.
6. The device and system protections – namely the overcurrent and I2t protection can be configured via on-board potentiometer/fixed resistors as described in the section above.
7. It is recommended to apply the pulsed sequence on digital inputs (if using one) and observing the same on oscilloscope for verification before switching on the power supply at VD. This ensures that the applied pulse duration, signal sequence, PWM/duty cycle (if required) etc. on IN and CS_EN is as desired by the user.
8. Finally, the power supply can be switched on and user can observe/monitor output voltage, load current, current sense output and other signals as desired.

The current sense signal as an input to LM321 buffer is voltage-divided per the equation below:

attenuation protects the Arduino/microcontroller input from high voltage levels and must be accounted for while doing digitization/processing of the current sense signal using Arduino or external microcontroller.



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EVALUATION BOARD GRAPHICAL USER INTERFACE

A User Interface and Arduino sketch are paired with the evaluation board.

The GUI will be disabled until a connection to the Arduino is established. To connect:

1. Refresh the COM ports with the 'Refresh COM Ports' button.
2. Select the correct COM port with the dropdown.
3. Click 'Connect to Arduino'.

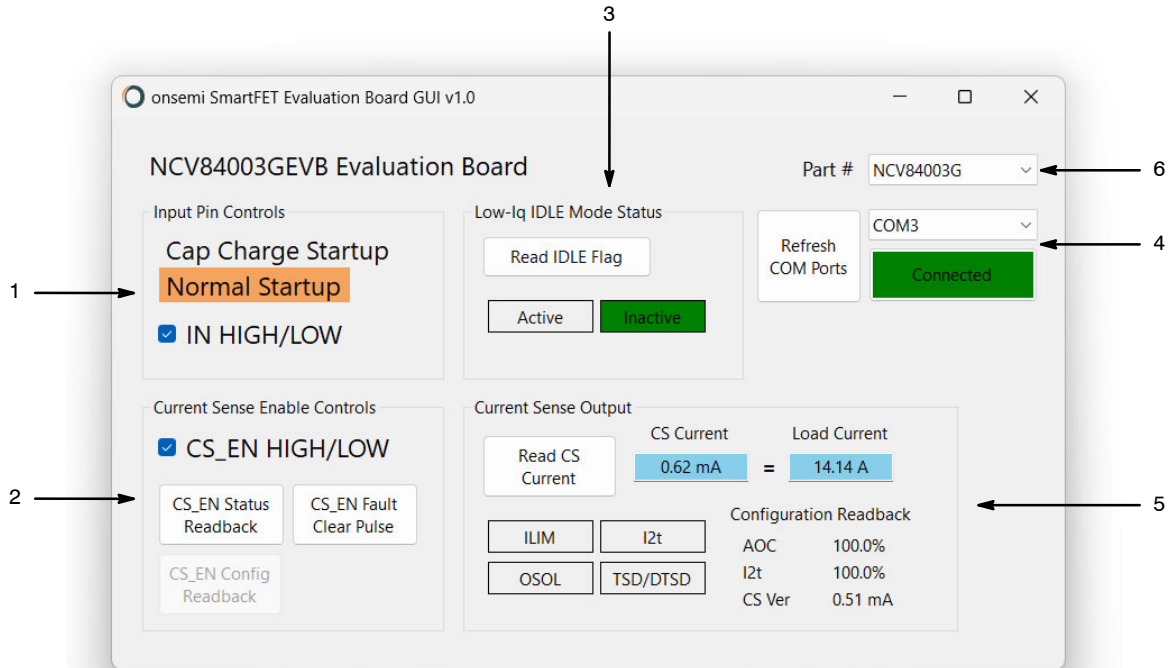


Figure 7. Evaluation Board GUI Usage

1. *Input Pin Controls*: Check/uncheck the box to control the IN pin. The startup mode will be highlighted depending on the state of the CS_EN pin.
2. *Current Sense Enable Controls*: Check/uncheck the box to control the CS_EN pin. If the IN pin is HIGH, the GUI will allow a Fault Clear Pulse via the CS_EN pin. A Status Readback or Configuration Readback Pulse will be available depending on the state of the IN pin.
3. *Low-Iq IDLE Mode Status*: The state of the IDLE Flag pin is displayed in this section. The 'Read IDLE Flag' button will be enabled if either IN or CS_EN is HIGH.
4. *Arduino COM Port Controls*: The 'Connect to Arduino' button will change to 'Connected' or 'Disconnected' if the status of the Arduino serial connection is changed. Click the button to change the status.
5. *Current Sense Output*: The output of the CS pin is displayed in this section. If the CS_EN pin is high, the GUI will enable the 'Read CS Current' button. If a fault is flagged on the CS Pin, one of the fault indicators will turn red. If a Config Readback Pulse is sent, the resistor settings will be updated here.
6. *Part Number Dropdown*: This dropdown will change the CS Ratio used in the 'Current Sense Output' section.

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BILL OF MATERIALS (BOM)

Table 4. BILL OF MATERIALS FOR THE NCV840XXGNTGEVB

Designator (Main Board)	Quantity	Description	Value	Tolerance	Footprint	Manufacturer	Manufacturer Part Number	Subst. Allowed	Lead Free
Rpu	1	1.5 kOhms ±1% 0.125W, 1/8W Chip Resistor 0603	1.5 kOhms	±1%	0603	Stackpole Electronics	RNCP0603TFD1K50	Yes	Yes
Rpd	1	47 kOhms ±1% 0.125W, 1/8W Chip Resistor 0603	47 kOhms	±1%	0603	Panasonic	ERJ-H3EF4702V	Yes	Yes
R4	1	RES SMD 680 OHM 5% 1/8W 0805	680 Ohms	±5%	0805	Panasonic	ERJ-6GEYJ681V	Yes	Yes
R5	1	RES 510 OHM 5% 1/8W 0805	510 Ohms	±5%	0805	Stackpole Electronics	RMCF0805JT510R	Yes	Yes
R2, R3, R6, R8, R11	5	4.7 kOhms ±1% 0.125W, 1/8W Chip Resistor 0805	4.7 kOhms	±1%	0805	Yageo	RC0805FR-074K7L	Yes	Yes
R9	1	10 kOhms ±1% 0.125W, 1/8W Chip Resistor 0805	10 kOhms	±5%	0805	Stackpole Electronics	RMCF0805JT10K0	Yes	Yes
R10	DNP	4.7 kOhms ±1% 0.125W, 1/8W Chip Resistor 0805	4.7 kOhms	±1%	0805	Yageo	RC0805FR-074K7L	Yes	Yes
R1 (Rgnd)	1	47 Ohms ±1% 0.125W, 1/8W Chip Resistor 0805	47 Ohms	±1%	0805	Stackpole Electronics	RMCF0805FT47R0	Yes	Yes
J1, J4, J6, J8, J10, J11, J13, J15, J17	DNP	0 Ohms Jumper Chip Resistor 0603	0 Ohms	±5%	0603	Stackpole Electronics	RMCF0603ZT0R00	Yes	Yes
J2, J3, J5, J7, J9, J12, J14, J16	8	0 Ohms Jumper Chip Resistor 0603	0 Ohms	±5%	0603	Stackpole Electronics	RMCF0603ZT0R00	Yes	Yes
C2 (Csupply)	1	100nF ±10% 50V Ceramic Capacitor X5R 1210	100 nF	±10%	1210	KEMET	C1210C104K5RACTU	Yes	Yes
C4 (Ccs)	1	100pF ±5% 50V Ceramic Capacitor X7R 0805	100 pF	±5%	0805	Yageo	CC0603JRNPO9BN101	Yes	Yes
C3 (C_VD_GND)	1	47nF ±10% 50V Ceramic Capacitor X7R 0603	47 nF	±10%	0603	Walsin Technology	0603B473K500CT	Yes	Yes
C1 (Cout)	1	10nF 50V Ceramic Cap 0603	10 nF	±5%	0603	KEMET	C0603C103J5RACTU	Yes	Yes
C6	1	1uF 50V Ceramic Cap 0805	1 uF	±10%	0805	Samsung Electro-Mechanics	CL21B105KBFNNE	Yes	Yes
C5	1	330nF 50V Ceramic Cap 0805	330 nF	±10%	0805	TDK Corporation	CGA4J2X7R1H334K125DA	Yes	Yes
U3	1	Linear Voltage Regulator IC Positive Fixed 1 Output 1A DPAK	Linear Voltage Reg Linear	N/A	DPAK3_SMD	onsemi	MC7805BDTG	Yes	Yes
D1	1	Diode Schottky 50V 2A Surface Mount DO-214AA (SMB)	50V, 2A	N/A	SMB DIODE	onsemi	SS25	Yes	Yes
"I2t_ADJ", "AOC"	2	TRIMMER 50K OHM 0.5W PC PIN TOP	50k Pot	±10%	3386F_1_503TLF	Bourns Inc	3386F-1-503TLF	Yes	Yes
U8	1	IC OPAMP GP 1 CIRCUIT 5TSOP	GP OP AMP	N/A	TSOP-5	onsemi	LM321SN3T1G	No	Yes
U1	1	Self-Protected High Side Driver With IDLE Mode & Analog Current Sense	N/A	N/A	TSSOP 14EP	onsemi	NCV840XXGPAR2G	No	Yes
VD, OUT, GND	3	CONN BIND POST KNURLED	Connector Header Connector	N/A	BANANA	Cinch Connectivity Solutions	111-2223-001	Yes	Yes
U2 (Arduino and Headers)	2	CONN HDR 15POS 0.1 TIN PCB		N/A	ARDUINON ANO	Sullins Connector Solutions	PPTC151LFBN-RC	Yes	Yes
	1	Arduino Nano Every Microcontroller	ucontroller	N/A		Arduino	ABX00028	No	Yes
	1	CBL USB2.0 A PLUG-MIN A PLUG 6'	N/A	N/A		Stewart Connector	SC-2ANK006F	Yes	Yes
J37 ("TO Ext. uC" 6 pos Header)	1	CONN HDR 6POS 0.1 TIN PCB	Connector Header Connector	N/A	JP6	Sullins Connector Solutions	PPTC061LFBN-RC	Yes	Yes
(Board Standoffs) TP84, TP85, TP86, TP87	4	HEX STANDOFF #4-40 ALUMINUM 3/4"	N/A	N/A	#4MOUNT	Keystone Electronics	2204	Yes	Yes
	4	Machine Screw Pan Phillips #4-40 x 1/4"					9900	Yes	Yes
GND, VCC, IN, CS_EN, CS, IDLE_FLG, I2t_ADJ, AOC, DUT_GND, OUT_S, VD_S	11	Test Point	N/A	N/A	TP	Vector Electronics	K31C/M	Yes	Yes

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R4	1	RES SMD 680 OHM 5% 1/8W 0805	680 Ohms	±5%	0805	Panasonic	ERJ-6GEYJ681V	Yes	Yes
R5	1	RES 510 OHM 5% 1/8W 0805	510 Ohms	±5%	0805	Stackpole Electronics	RMCF0805JT510R	Yes	Yes
R2, R3, R6, R8, R11	5	4.7 kOhms ±1% 0.125W, 1/8W Chip Resistor 0805	4.7 kOhms	±1%	0805	Yageo	RC0805FR-074K7L	Yes	Yes
R9	1	10 kOhms ±1% 0.125W, 1/8W Chip Resistor 0805	10 kOhms	±5%	0805	Stackpole Electronics	RMCF0805JT10K0	Yes	Yes
R10	DNP	4.7 kOhms ±1% 0.125W, 1/8W Chip Resistor 0805	4.7 kOhms	±1%	0805	Yageo	RC0805FR-074K7L	Yes	Yes
R1 (Rgnd)	1	47 Ohms ±1% 0.125W, 1/8W Chip Resistor 0805	47 Ohms	±1%	0805	Stackpole Electronics	RMCF0805FT47R0	Yes	Yes
J1, J3, J4, J5, J6, J7, J8, J9, J10, J11, J12, J15, J17	DNP	0 Ohms Jumper Chip Resistor 0603	0 Ohms	±5%	0603	Stackpole Electronics	RMCF0603ZT0R00	Yes	Yes
J2, J13, J14, J16	4	0 Ohms Jumper Chip Resistor 0603	0 Ohms	±5%	0603	Stackpole Electronics	RMCF0603ZT0R00	Yes	Yes
C2 (Csupply)	1	100nF ±10% 50V Ceramic Capacitor X5R 1210	100 nF	±10%	1210	KEMET	C1210C104K5RACTU	Yes	Yes
C4 (Ccs)	1	100pF ±5% 50V Ceramic Capacitor X7R 0805	100 pF	±5%	0805	Yageo	CC0603JRNPO9BN101	Yes	Yes
C3 (C_VD_GND)	1	47nF ±10% 50V Ceramic Capacitor X7R 0603	47 nF	±10%	0603	Walsin Technology	0603B473K500CT	Yes	Yes
C1 (Cout)	1	10nF 50V Ceramic Cap 0603	10 nF	±5%	0603	KEMET	C0603C103J5RACTU	Yes	Yes
C6	1	1uF 50V Ceramic Cap 0805	1 uF	±10%	0805	Samsung Electro-Mechanics	CL21B105KBFNNE	Yes	Yes
C5	1	330nF 50V Ceramic Cap 0805	330 nF	±10%	0805	TDK Corporation	CGA4J2X7R1H334K125DA	Yes	Yes
U3	1	Linear Voltage Regulator IC Positive Fixed 1 Output 1A DPAK	Linear Voltage Regulator	N/A	DPAK3_SMD	onsemi	MC7805BDTG	No	Yes
D1	1	Diode Schottky 50V 2A Surface Mount DO-214AA (SMB)	50V, 2A	N/A	SMB DIODE	onsemi	SS25	No	Yes
"I2t_ADJ", "AOC"	2	TRIMMER 50K OHM 0.5W PC PIN TOP	50k Pot	±10%	3386F_1_503TLF	Bourns Inc	3386F-1-503TLF	Yes	Yes
U8	1	IC OPAMP GP 1 CIRCUIT 5TSOP	GP OP AMP	N/A	TSOP-5	onsemi	LM321SN3T1G	No	Yes
U1	1	Self-Protected High Side Driver With IDLE Mode & Analog Current Sense	N/A	N/A	TSSOP 14EP	onsemi	NCV840XXGPAR2G	No	Yes
VD, OUT, GND	3	CONN BIND POST KNURLED	Connector Header Connector	N/A	BANANA	Cinch Connectivity Solutions	111-2223-001	Yes	Yes
U2 (Arduino and Headers)	DNP	CONN HDR 15POS 0.1 TIN PCB	Connector Header Connector	N/A	ARDUINON ANO	Sullins Connector Solutions	PPTC151LFBN-RC	Yes	Yes
	DNP	Arduino Nano Every Microcontroller	ucontroller	N/A		Arduino	ABX00028	No	Yes
	DNP	CBL USB2.0 A PLUG-MIN A PLUG 6"	N/A	N/A		Stewart Connector	SC-2ANK006F	Yes	Yes
J37 ("TO Ext. uC" 6 pos Header)	DNP	CONN HDR 6POS 0.1 TIN PCB	Connector Header Connector	N/A	JP6	Sullins Connector Solutions	PPTC061LFBN-RC	Yes	Yes
(Board Standoffs) TP84, TP85, TP86, TP87	4	HEX STANDOFF #4-40 ALUMINUM 3/4"	N/A	N/A	#4MOUNT	Keystone Electronics	2204	Yes	Yes
	4	Machine Screw Pan Phillips #4-40 x 1/4"	N/A	N/A			9900	Yes	Yes
GND, VCC, IN, CS_EN, CS, IDLE_FLG, I2t_ADJ, AOC, DUT_GND, OUT_S, VD_S	11	Test Point	N/A	N/A	TP	Vector Electronics	K31C/M	Yes	Yes

NCV840XXGEVB

REVISION HISTORY

Revision	Description of Changes	Date
0	Initial document release.	4/28//2026
1	Edit orderable part numbers throughout document, one value edit table 1, text edits board operation section, replace tables 4 and 5	6/10/2026

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